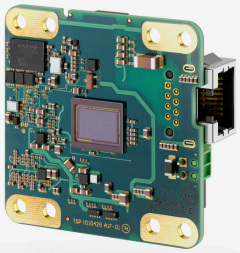
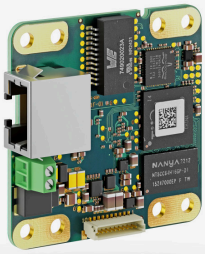
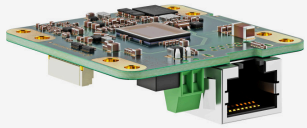
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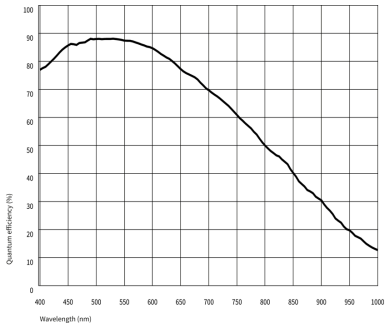
In series
The model is in series and available for the long term.

Specification

Sensor

Sensor type	CMOS Mono
Shutter	Global Shutter
Sensor characteristic	Linear
Pixel Class	3 MP
Resolution	3.20 Mpix
Resolution (h x v)	2064 x 1552 Pixel
Aspect ratio	4:3
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1/3.1"
Optical Size	4.644 mm x 3.492 mm
Optical sensor diagonal	5.81 mm 1/3.1"
Pixel size	2.25 µm
CRA (Chief Ray Angle)	8 °
Manufacturer	Sony
Sensor Model	IMX900-AMR-C
Gain (master/RGB)	16x/-
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	256 / 2
AOI image height / step width	1 / 1
AOI position grid (horizontal/vertical)	2 / 1
Binning horizontal	increased frame rate
Binning vertical	increased frame rate
Binning method	Horizontal: mean / Vertical: mean
Binning factor	2x2
Decimation (subsampling) horizontal	-
Decimation (subsampling) vertical	-
Decimation (subsampling) method	M/C automatic



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Model

Frame rate freerun mode	39 fps
Frame rate trigger (continuous)	39 fps
Frame rate trigger (maximum)	50 fps
Exposure time (minimum - maximum)	0.023 ms - 2000 ms
Power consumption	0 W - 0 W
Image memory	128 MB

HDR

Mode	QuadHDR

Ambient conditions

For PCB versions, refer to the separate hints in the respective documentation.

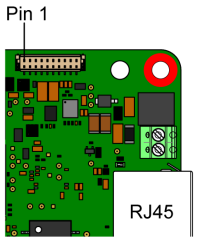
Allowed device temperature during operation	0 °C - 80 °C / 32 °F - 176 °F
Allowed ambient temperature during operation	0 °C - 25 °C / 32 °F - 77 °F
Allowed ambient temperature during storage	-20 °C - 60 °C / -4 °F - 140 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	GigE RJ45
I/O connector	10-pin Wuerth connector (WR-WTB 1.00 mm)
Power supply	12 V - 24 V

Pin assignment I/O connector

1	Power supply (VCC) 12-24 V
2	Power supply, ground
3	General Purpose I/O (GPIO) 2, 3.3 V - Line 3
4	General Purpose I/O (GPIO) 1, 3.3 V - Line 2
5	I2C SCL (signal clock) 3.3 V
6	I2C SDA (signal data) 3.3 V
7	Trigger input without optocoupler 3.3 V - Line 0
8	Flash output without optocoupler 3.3 V - Line 1
9	Ground (GND)
10	Voltage output 3.3 V, max. 100 mA



Design

Lens Mount	No mount
IP code	-
Dimensions H/W/L	45.0 mm x 45.0 mm x 15.0 mm
Mass	15 g
Housing material	-

Features

List of on-camera image pre-processing features.
All features of the table are available via our IDS peak software for image pre-processing on the host computer (sensor model dependent).

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GV-53D2LE-M Rev.2 (1011711)

Image Acquisition	Freerun	✓
	Software trigger	✓
	Hardware trigger	✓
	Trigger controlled exposure	-
	Denoiser	✓
	Long exposure	-
	Line scan	-
Flashing	Flashing	✓
	PWM flashing	-
Image Adjustments	Auto exposure	✓
	Auto gain	✓
	Auto whitebalance	-
	Color correction	-
	Gamma	-
	LUT	-
	Mirror/flip	X/Y
On-board Image Processing	Pixel formats	Mono8 Mono10 Mono10p Mono12 Mono12p
	Region of interest	✓
	Decimation (FPGA)	✓
	Decimation (Sensor)	
	Binning (FPGA)	-
	Binning (Sensor)	2x2 Increases frame rate.
Others	IP settings	✓
	Bandwidth management	✓
	Chunks	-
	Sequencer	-
	PTP	✓
	Firmware update	✓
	1st supported firmware version	3.62.25422

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